Transmitted herewith for filing is the patent application of:

**ALEXANDRIA, VA 22313-1450** 

I HEREBY CERTIFY THIS PAPER OR FEE IS BEING DEPOSITED WITH THE U.S. POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE" SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED BELOW AND IS ADDRESSED TO: MS PATENT APPLICATION, COMMISSIONER FOR PATENTS, PO BOX 1450, ALEXANDRIA, VA 22313-

EXPRESS MAIL NO: EV301516187US DATE OF DEPOSIT: November 4, 2003

NAME: JUSTIN GOCKE SIGNATURE:

Inventors:

Pierre MORIN

Jorge Luis REGOLINI

For:

[X]

SEMICONDUCTOR DEVICE WITH MOS TRANSISTORS WITH AN ETCH-STOP LAYER HAVING AN IMPROVED RESIDUAL STRESS LEVEL AND METHOD FOR

FABRICATING SUCH A SEMICONDUCTOR DEVICE

Enc	lo <u>sed</u>	ar	e:

Patent Application: 14 pages, 11 claims

3 sheets of drawings
The suggested drawing figure to be published is FIG. 3.
Citation Under 37 CFR 1.97 and PTO-1449

A Preliminary Amendment (with \_\_1\_\_ replacement drawing sheets).

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Country of Incorporation: France

Applicant claims priority benefit to the following foreign application(s): France

Country:

Application No.: 0213837

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The Declaration and Filing Fee are **NOT ENCLOSED**.

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